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FGRM PTO-1595 (modified)					U.S. DEPARTMENT O	OF COMMERCE
(Rev 6-93)	RI			≀ SHEET	Patent a	nd Trademark Office
		101895313	}			
To the Director of the Unite	d States Pat		ffice: Plea	se record the a	ittached original do	cuments or
Name of conveying party	(ies):			d address of re	eceiving party(ies):	
11	1071	191				
Osamu KOIKE			292 Yo	shida-cho, Tots	ING EDGE TECHNOLO suka-ku 244-0817, Japan	09/986044 S. W. W. S. W.
Additional conveying part	ty(ies)	NO				8.8 860
3. Nature of conveyance:						20
ASSIG	NMENT					56
Execution Date:				() 0 1 1	() () 12	
Septembe 4. Application number(s) or	r 13, 2001		dditional n	ame(s) & addre	ess(es) attached?	NO
If this is being filed together September 13, 2001 A. Patent Application 1/08/2001 EFLORES 00000011 0998 2 FC:581	on Number(s	İ		Patent Number(2	
		Additional numbers	attached?	NO		
5. Name and address of par concerning document sho		correspondence 6			itions/patents involv	ved: 1
		7	. Total fee	: (37 C.F.R. § 3	3.41):	\$40.00
William T. Ellis FOLEY & LARDNER		<u>x</u>	Check	Enclosed		
Washington Harbour 3000 K Street, N.W.			Charge	to deposit acc	count	
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9. Statement and signature: To the best of my kr is a true copy of the original fees which may be required William T. Ellis	nowledge an document.	nd belief, the foregoing The Commissioner is er to the above-identif	hereby aut	th gr ized to chai	rge any additional r	eched copy ecordation eer 7, 2001
Name of person sig	ning		Signatur	e		Date

002.662779

PATENT REEL: 012299 FRAME: 0836

Total number of pages including cover sheet, attachments, and document:

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

Osamu KOIKE

who has made a certain new and useful invention, hereby sells, assigns and transfers unto

Semiconductor Leading Edge Technologies, Inc. 292 Yoshida-cho, Totsuka-ku Yokohama, Kanagawa 244-0817 JAPAN

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

PLASMA ETCHING APPARATUS WITH FOCUS RING AND PLASMA ETCHING METHOD

for which an application for United States Letters Patent was executed on even date herewith,

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the international Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

INVENTOR

DATE SIGNED

Usamu

Osamu KOIKE

RECORDED: 11/07/2001

13/ Saptember/2001

PATENT REEL: 012299 FRAME: 0837